PRODUCT DATA SHEET

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Datasheet Resources Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO_questions@jgsemi.com.

General Description

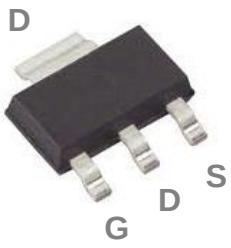
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

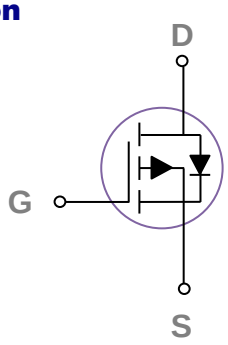
BVDSS	RDSON	ID
-60V	160mΩ	-2.0A

Features

- *-60V,-2.0A, RDS(ON) =160mΩ@VGS = -10V*
- *Improved dv/dt capability*
- *Fast switching*
- *Green Device Available*

SOT223 Pin Configuration





Applications

- *Motor Drive*
- *Power Tools*
- *LED Lighting*

Absolute Maximum Ratings Tc=25℃ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current – Continuous (T_A=25℃)	-2.0	A
	Drain Current – Continuous (T_C=25℃)	-4	A
I_{DM}	Drain Current – Pulsed[1] (T_A=25℃)	-10.8	A
P_D	Power Dissipation (T_A=25℃)	2	W
	Power Dissipation (T_C=25℃)	5.4	W
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 125	℃

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	60	℃/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	23	℃/W

Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=-250uA	-60	---	---	V
$\triangle BV_{DSS}/\triangle T_J$	BV_{DSS} Temperature Coefficient	Reference to 25℃ , I_D=-1mA	---	-0.05	---	V/℃
I_{DSS}	Drain-Source Leakage Current	V_{DS}=-60V , V_{GS}=0V , T_J=25℃	---	---	-1	uA
		V_{DS}=-48V , V_{GS}=0V , T_J=125℃	---	---	-10	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V , V_{DS}=0V	---	---	±100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-10V , I_D=-2A	---	160	200	mΩ
		V_{GS}=-4.5V , I_D=-1A	---	180	230	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS} , I_D=-250uA	-1.0	-1.6	-2.5	V
$\triangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	3	---	mV/℃
gfs	Forward Transconductance	V_{DS}=-10V , I_D=-2A	---	5.5	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge[3,4]	V_{DS}=-30V , V_{GS}=-10V , I_D=-2A	---	10	15	nC
Q_{gs}	Gate-Source Charge[3,4]		---	1.6	3.2	
Q_{gd}	Gate-Drain Charge[3,4]		---	3	6	
$T_{d(on)}$	Turn-On Delay Time[3,4]	V_{DD}=-30V , V_{GS}=-10V , R_G=6Ω , I_D=-1A	---	8	16	ns
T_r	Rise Time[3,4]		---	15.4	30	
$T_{d(off)}$	Turn-Off Delay Time[3,4]		---	42.8	80	
T_f	Fall Time[3,4]		---	8.4	16	
C_{iss}	Input Capacitance	V_{DS}=-30V , V_{GS}=0V , F=1MHz	---	785	1300	pF
C_{oss}	Output Capacitance		---	175	300	
C_{rss}	Reverse Transfer Capacitance		---	112	220	
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, F=1MHz	---	36	---	Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	V_G=V_D=0V , Force Current	---	---	-2.0	A
I_{SM}	Pulsed Source Current		---	---	-4.0	A
V_{SD}	Diode Forward Voltage	V_{GS}=0V , I_S=-1A , T_J=25℃	---	---	-1.2	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=-25V,V_{GS}=-10V,L=0.1mH,I_{AS}=-18A.,R_G=25Ω,Starting T_J=25℃.
3. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%.
4. Essentially independent of operating temperature.

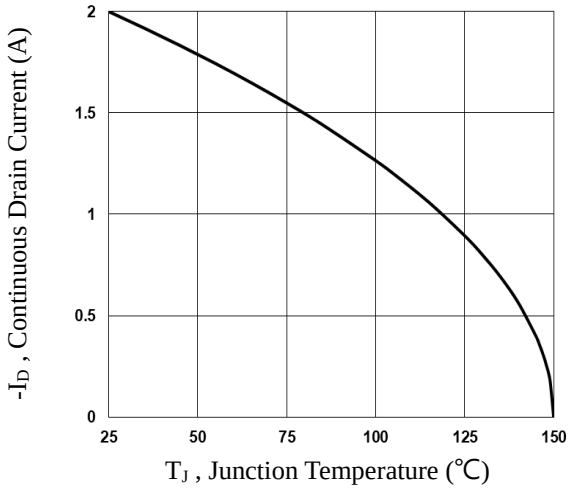


Fig.1 Continuous Drain Current vs. T_J

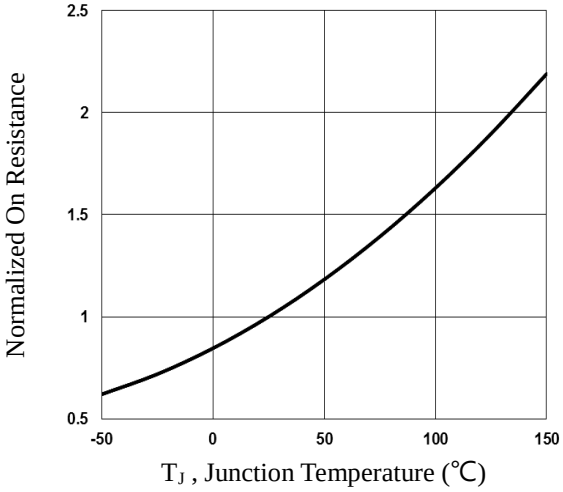


Fig.2 Normalized RDSON vs. T_J

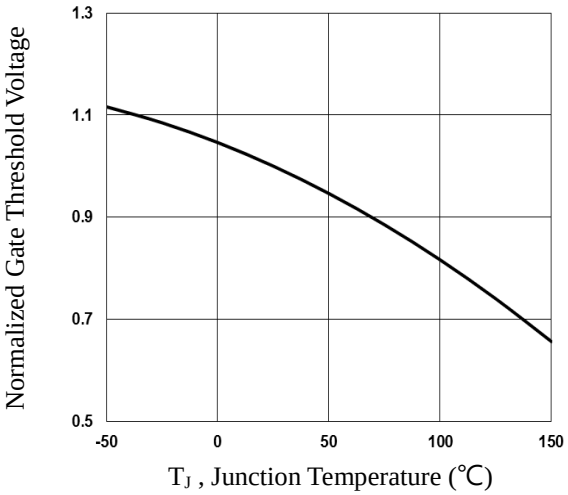


Fig.3 Normalized V_{th} vs. T_J

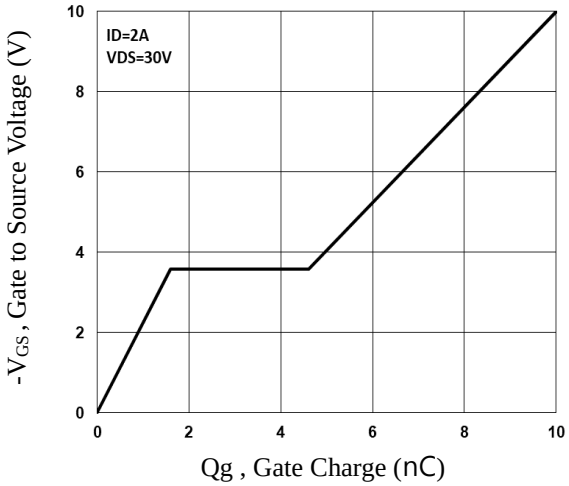


Fig.4 Gate Charge Waveform

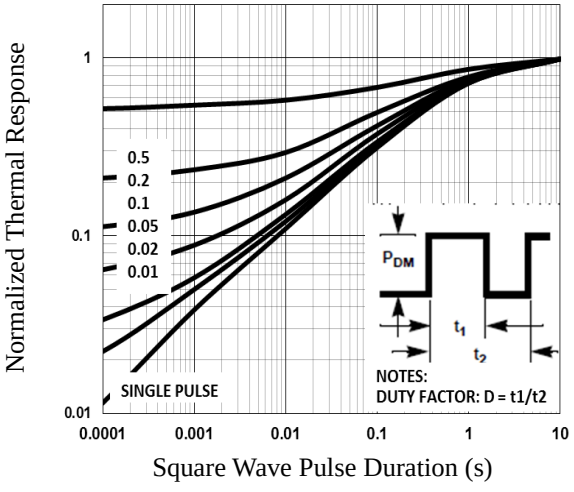


Fig.5 Normalized Transient Impedance

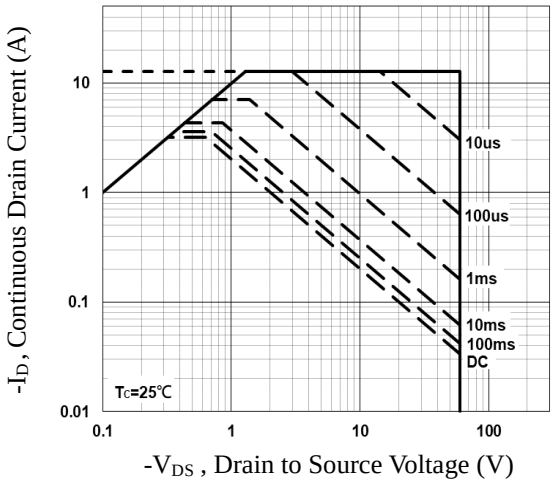
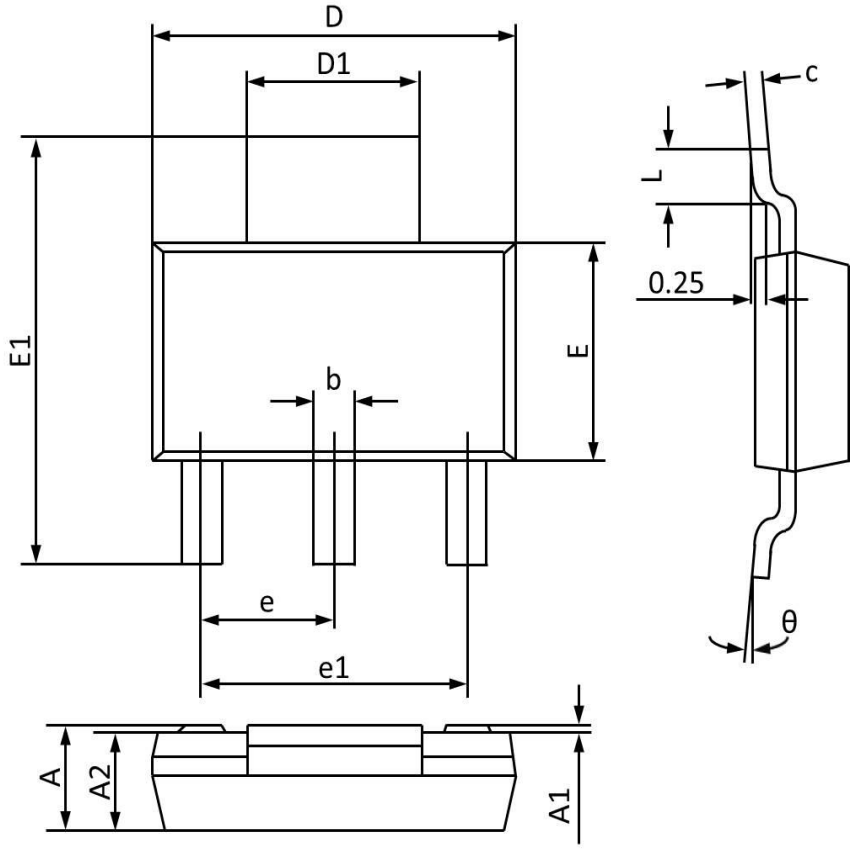


Fig.6 Maximum Safe Operation Area

SOT223 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	1.800	1.520	0.071	0.060
A1	0.100	0.000	0.004	0.000
A2	1.700	1.500	0.067	0.059
b	0.820	0.660	0.032	0.026
c	0.350	0.250	0.014	0.010
D	6.400	6.200	0.252	0.244
D1	3.100	2.900	0.122	0.114
E	3.700	3.300	0.146	0.130
E1	7.070	6.830	0.278	0.269
e	2.30(BSC)		0.091(BSC)	
e1	4.700	4.500	0.185	0.177
L	1.150	0.900	0.045	0.035
θ	10°	0°	10°	0°

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